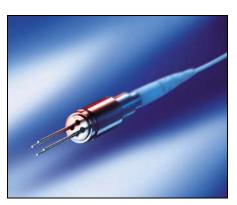


Ternary PIN Photodiode with integrated Preamplifier IC

SRP00254x SRP00255x

Features

- InGaAs/InP PIN photodiode with preamplifier IC
- Designed for SONET OC-12 / SDH STM-4 applications in fiber-optics communication systems
- Sensitive receiver for 2nd and 3rd optical window (1300 nm and 1550 nm)
- Suitable for bit rates up to 622 Mbit/s
- Module with high optical sensitivity
- · Fast switching times
- · Low dark current
- Excellent noise immunity
- High reverse current stability from planar structure
- Hermetically sealed TO46 package







Pin Configuration

Pin Configuration

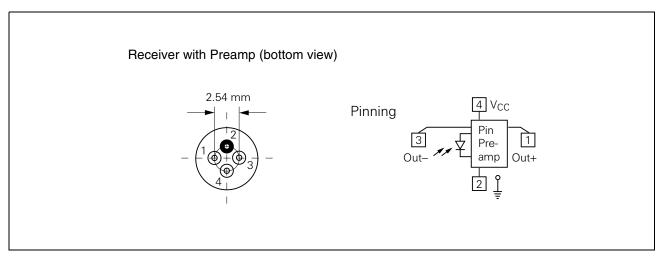


Figure 1 Receiver with Preamp



Description

Description

The Infineon optical receiver module has been designed for use in optical networks and is suitable for bit rates up to max. 2.5 Gbit/s if used without any TIA.

The optical receiver module uses a high-speed PIN photodetector optional coupled with a hybrid low noise transimpedance amplifier (PIN-TIA). The optical receiver photodiode can be used for 1310 nm or 1550 nm optical communications.

The PIN photodiode is made of InGaAs/InP and has an active diameter of 75 μ m. The function of the PIN and PIN-TIA optical receiver module is to detect input optical power, to transduce the incident radiation into current (PIN) and then to convert the current into a voltage (PIN-TIA).

The low input noise current density of the used transimpedance amplifiers in PIN-TIA's provides the optical receiver module, when used with appropriate filtering, with ample sensitivity for realizing minimum input power requirements. Designers of optical receivers can use the module in any application that benefits from integration of the photodiode and TIA into a TO coaxial package. Typical for such applications are receivers for digital crossconnects, digital loop carriers, add/drop-multiplexers and optical network units.

Last but not least the fast switching times, low dark currents and the packaging in a compact and hermetically sealed TO46 make the optical receivers usable in many other fiber optic receiver applications. One application is the use in a Compact realization of a transceiver in one module like the so called BIDI® (Figure 2).

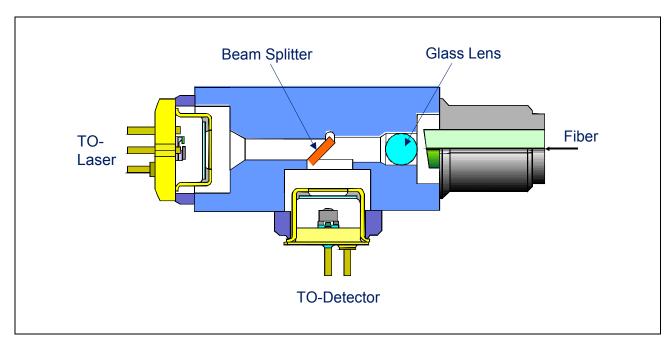


Figure 2 Compact Realization of the Transceiver in One Module



Technical Data

Technical Data

Absolute Maximum Ratings

Parameter	Symbol	Limit Values		Unit
		min.	max.	
Module	•	-		1
Operating temperature range at case	T_{C}	-40	85	°C
Storage temperature range	$T_{ m stg}$	-40	85	
Soldering temperature ($t_{max} = 10 \text{ s}$, 2 mm distance from bottom edge of case)	$T_{\mathbb{S}}$		260	
Receiver Diode	•			1
Reverse Voltage	V_{R}		20	V
Forward Current	I_{F}		10	mA
Optical power into the optical port	P_{port}		1	mW

The electro-optical characteristics described in the following table are only valid for use within the specified maximum ratings or under the recommended operating conditions. Characteristics for Pin-Preamp Receivers at $T_{\rm A}$ = 25°C, unless otherwise specified.

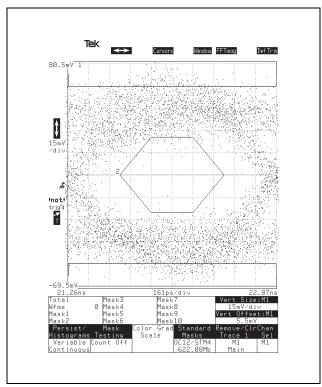
Preamp Characteristics

Parameter	Symbol	Limit Values		lues	Unit
		min.	typ.	max.	
DC-Characteristics	•				
Supply Voltage	$V_{\sf CC}$	4.5	5	5.5	V
Supply Current	$I_{\rm CC}$	35	47	65	mA
AC-Characteristics					
Optical Sensitivity (BER ≤ 10 ⁻⁹ , PN23)	S	-29	-31		dBm
Linear Bandwidth (-3 dB)	BW		400		MHz
Optical overload (avg.)	P_{max}		0		dBm
Transimpedance (single ended)	R_{T}	40	50	60	kΩ
Output resistance	R_{out}	48	60	72	Ω
Gain (differential)	G		80		V/mW
Return Loss, λ = 1310 nm	RL			-27	dB



Technical Data

Some Eye Diagrams



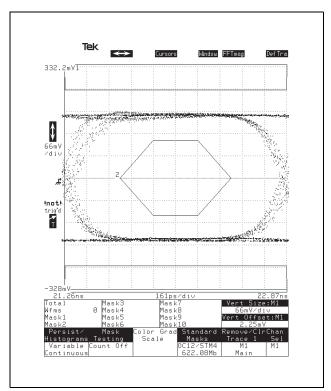
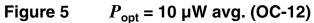
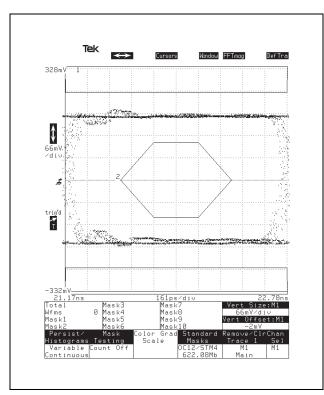


Figure 3 $P_{\text{opt}} = 1 \mu \text{W avg. (OC-12)}$





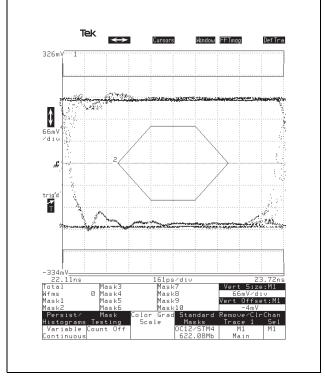


Figure 4 $P_{\text{opt}} = 100 \,\mu\text{W}$ avg. (OC-12) Figure 6

Figure 6 $P_{\text{opt}} = 500 \, \mu\text{W avg. (OC-12)}$



Fiber Data

Fiber Data

The mechanical fiber characteristics are described in the following table.

Fiber Characteristics

Parameter	Limit Values			Unit
	min.	typ.	max.	
Mode Field Diameter		50		μm
Cladding Diameter	123	125	127	
Mode Field/Cladding Concentricity Error			1	
Cladding Non-circularity			2	%
Mode Field Non-circularity			6	
Cut off Wavelength	1270			nm
Jacket Diameter	0.8		1	mm
Bending Radius	30			
Tensile Strength Fiber Case	5			N
Length	0.8		1.2	m



Package Outlines

Package Outlines

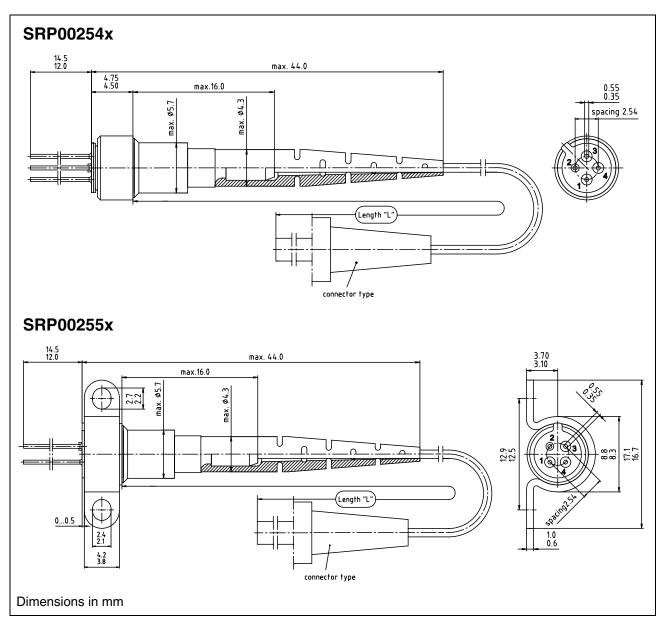


Figure 7



Package Outlines

Flange Options

Туре	Flange
SRP00254x	without
SRP00255x	with

Connector Options

Model	Туре
SRP00254H SRP00255H	MM FC/PC
SRP00254G SRP00255G	SM FC/PC
SRP00254O SRP00255O	MM SC/PC 0°
SRP00254N SRP00255N	SM SC/PC 0°
SRP00254Q SRP00255Q	MM SC 8° APC
SRP00254P SRP00255P	SM SC 8° APC
SRP00254W SRP00255W	MM without connector
SRP00254Z SRP00255Z	SM without connector

Other connectors on request

SRP0025	4x
SRP0025	5x
Revision	His

Revision History: 2001-12-01 DS0

Previous Version:

Page	Subjects (major changes since last revision)
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